

# TP44200SG-DPT-EVB

# Switching Test Evaluation Board

# For

# Tagore Technology's Superior GaN FET (TP44200SG)

# **User Manual**

# Rev-1.1

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# Tagore Technology

# 200SG-DPT-EVB

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### 1 Introduction

This Double Pulse Test (DPT) Evaluation Board (EVB) TP44200SG-DPT-EVB provides users the platform to evaluate the switching behavior of Tagore Technology's "Enhancement Mode High Electron Mobility GaN Transistors (E-HEMTs) with ESD protection" parts. This document should be used as a user guide only by professionals with adequate technical knowledge. TP44200SG-DPT-EVB can be used to measure switching energy loss, turn-on, and turn-off time.

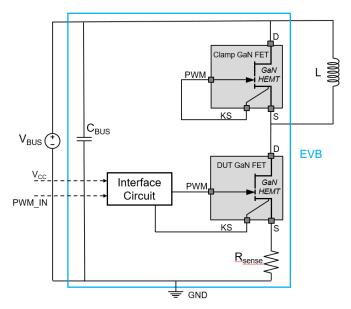


Figure 1-1: Simplified Circuit Diagram of Double Pulse Test Setup.

Figure 1-1 shows a simplified schematic of the Double Pulse Test setup using the TP44200SG-DPT-EVB. Tagore Technology's E-HEMT part, TP44200SG is shown as the Device Under Test (DUT). The test setup is fed from a HV DC power source whose voltage is denoted by  $V_{BUS}$ . An inductor of inductance L is connected between the drain of the DUT and the positive terminal of  $V_{BUS}$ . This inductor is not part of the EVB. When DUT turns on, current will flow from  $V_{BUS}$  to the DUT through the inductor. Another TP44200SG acts as the clamp diode. It helps freewheel the inductor current whenever the DUT turns off. The interface circuit provides isolation and adjusts the pulsed control signal (PWM\_IN) for the gate, as per the requirement of the DUT. A set of DC bus capacitors (combination of AI-electrolytic and ceramic capacitors, lumped as  $C_{BUS}$ ) is connected between the input terminals of  $V_{BUS}$  to limit voltage fluctuations. Control signal PWM\_IN, having two pulses (as shown in Figure 1-2), is fed to the DUT to turn it ON and OFF. When DUT turns ON, the inductor current will flow through the DUT.

Pulse #1 of duration t1 will determine the switching test current  $I_{SW}$  of the DUT as the inductor current  $I_L$  builds up from 0 to  $I_{SW}$  during this pulse. It remains almost constant at  $I_{SW}$  during the period t2 in between two pulses. It again starts increasing during the Pulse #2 with a duration of t3. The Turn-on and Turn-Off switching transitions can be captured in DSO during the rising edge of PWM pulse #2, and falling edge of PWM pulse #1, respectively.

The rise in inductor current  $\Delta I_L$  during pulse duration of  $t_n$  is given by the following equation:

$$\Delta I_L = \frac{V_{BUS}}{L} \cdot t_n$$

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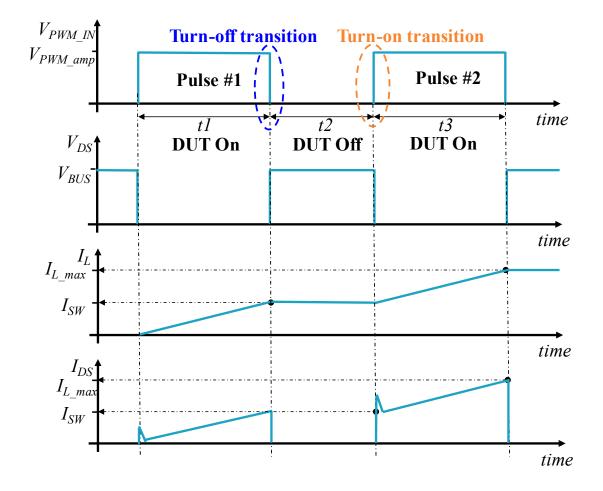


Figure 1-2: Timing Diagram of Double Pulse Test.

Users should be careful while selecting the pulse durations t1 and t3 as these time periods will determine the DUT currents for any given V<sub>BUS</sub> and L. It is recommended that before performing the actual DPT, the user should calculate the estimated values of t1, t2 and t3 based on the required current settings and V<sub>BUS</sub> and L values. The duration of t2 should not be too long to ensure that the inductor current stays nearly constant during this freewheeling period. Typically, t2 should be less than 1  $\mu$ s. The maximum Inductor and DUT current I<sub>L\_max</sub> should be within the recommended maximum pulsed current value mentioned in the datasheet of the DUT. The inductor should be chosen appropriately so that it can carry this current without getting saturated.



# 2 Physical Details Of EVB

Photographs of both the top and bottom sides of the TP44200SG-DPT-EVB are shown in Figure 2-1 with key components and test points identified.

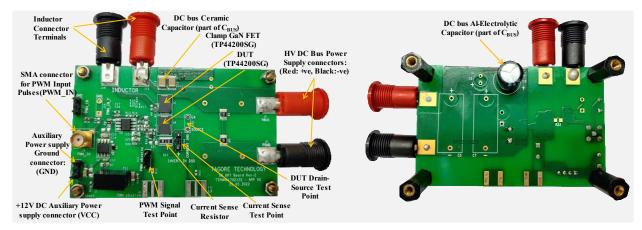


Figure 2-1: Photographs of TP44200SG-DPT-EVB with key components and test points identified. Top View (left); Bottom View (right).

### 2.1 Dimension Measurements

Table 2-1	:	Mechanica	Dimensions
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Mechanical Dimensions	Value	Unit
Length of EVB PCB	86.16	mm
Width of EVB PCB	55	mm
Thickness of PCB	1.6	mm
Height of tallest component on Top Side	12	mm
Height of tallest component on Bottom Side	21	mm

### 2.2 Technical Data

#### **Table 2-2 : Electrical Parameter Ratings**

Parameter	Symbol	Value	Unit	Comments
High Voltage (DC) Input	VBUS	400	V	Maximum
Auxiliary DC Power Supply Voltage	VCC_IN	12	V	0.2 A min. current rating
Amplitude veltage of input DWM pulse		5	V	Maximum
Amplitude voltage of input PWM pulse	PWM_IN	4	V	Minimum
Maximum Drain-Source current of DUT	I <sub>L_max</sub>	**	Α	Please check datasheet of
				DUT

\*\*Check the latest datasheet to get the Maximum Drain-Source current of DUT. Recommended value should not be exceeded.

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# **3 Operating Procedure**

### 3.1 List Of Instruments and Hardware Items Required

For DPT the following list of instruments and hardware items are required:

- TP44200SG-DPT-EVB eval board
- Inductor (preferably with shielding and low parasitic capacitance for cleaner waveforms)
- Controllable PWM signal source (preferably a DSP with 5V amplitude output)
- Power Sources:
  - Auxiliary power source: 12 V DC, 200mA (min)
  - High Voltage Power source: 400V DC (max)
- Observation Instruments:
  - Digital Storage Oscilloscope (*abr.* DSO) (Preferably with 4 Channels, BW ≥ 300 MHz)
  - High Voltage Probe (min. 500 V and preferably with spring ground lead) compatible with the DSO
  - Low Voltage Probe/Active Probe compatible with the DSO
  - Current Probe for observing Inductor current (optional)
- Wires and cables for making electrical connections.

### 3.2 Operating Procedure Steps

- <u>Step 1</u>: Connect an inductor in between the connectors J15 and J16 on the TP44200SG-DPT-EVB. Typically, the recommended value of the inductor is in the range of 50 μH to 100 μH.
- <u>Step 2</u>: Connect output from a controllable PWM signal source to either SMA connector J9 or header J7.
- <u>Step 3</u>: Connect output terminals of an Auxiliary 12 V DC source to the 2-pin header connector J1, to supply power to the interface circuit.
- <u>Step 4</u>: To observe the PWM input signal going into the DUT, connect a low-voltage probe from DSO to header connector J13.
- <u>Step 5</u>: To observe the Drain-Source voltage signal of the DUT, connect a high-voltage probe from DSO, at connector J12. More details on the probe connection are given in Section 3.3.
- <u>Step 6</u>: To observe the Drain-Source current signal of the DUT, connect an Active probe or a low voltage probe from DSO, at connector J14 and invert the signal in DSO. However, this step can be skipped if available DSO channels are limited. More details on the probe connection are given in Section 3.4.
- <u>Step 7</u>: (Optional) Connect current probe to any lead wire of the inductor.
- <u>Step 8</u>: Turn on the 12 V DC source output with a current limit of 200mA, and then turn on the HV DC source output. It is recommended to first check the test setup at low voltage (preferably less than 30 V). Then release a test pulse signal from the PWM signal generator and observe the waveforms in DSO.
- <u>Step 9</u>: If the test setup is ok, then gradually increase the HV DC source output to the desired value up to 400 V. Adjust the PWM pulse widths to get the desired DUT current (limit the peak current to the recommended values as per datasheet of the DUT), and then release the Double Pulse signal from PWM signal generator.

Note that the EVB is designed for the Double Pulse Test only. Make sure there is at least 100 ms rest period (no current period) available between two consecutive sets of pulses (in case of continuous operation) to provide sufficient cooling time for the DUT as there is no heatsink attached to it.

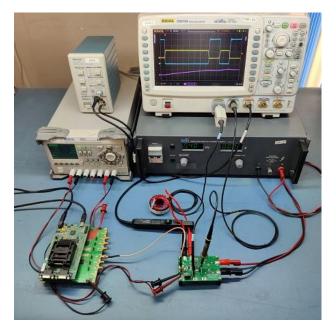


Figure 3-1: Typical Lab Test Setup for DPT.

## 3.3 Recommended Probe Connection to Observe DUT Drain-Source Voltage

For observing Drain-Source voltage waveform of DUT, the user can connect a voltage probe across the test point J12 with ground lead connected to the "Source" terminal and probe tip connected to the terminal marked as "LX".



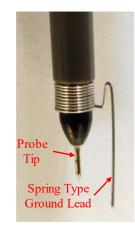


Figure 3-2: Recommended HV probe connection for observing Drain-Source voltage (Left image). Voltage probe with Spring Type Ground lead identified (Right image).

It is recommended to use spring lead for the ground connection of the voltage probe as shown in Figure 3-2. This will help in reducing noise in the waveform observed through DSO. The user should check and ensure that the voltage rating of the probe is higher than the applied HV DC bus voltage while testing the EVB.



### 3.4 Recommended Probe Connection to Observe DUT Drain-Source Current

For observing Drain-Source current waveform of DUT, the user can probe the voltage across the  $0.1\Omega$  current sense resistor on the EVB through the test point J14. The tip of the voltage probe should be inserted in the terminal marked by a (+) sign. This will ensure that the voltage probe connection is referred to the 'Source' node of the DUT. Invert this voltage probe signal in DSO to observe current flow from Drain to Source in correct polarity. It is recommended to use an Active probe as shown in Figure 3-3. This will help in reducing noise in the waveform observed through DSO. Alternatively, a low-voltage probe with spring-type ground lead can also be used to observe current waveform with better noise immunity.



Figure 3-3: Active probe connection for observing Drain-Source Current through current sense The current value in Ampere will be ten times (10X) that of the voltage measured in Volts since the current sense resistor is  $0.1\Omega$ . For example, 100 mV across the current sense resistor corresponds to 1 A Drain-Source current.



# 4 Key Switching Waveforms Observed From DSO

Figure 4-1: Typical Double Pulse Test Waveform captured using DSO. Channel 1(Blue): PWM input (5 V/div); Channel 2(Red): Drain-Source voltage (100 V/div); Channel 3(Green): Inductor Current (5 A/div); Channel 4(Orange): Voltage across 0.1 Ω current sense resistor (500 mV/div); Time scale: 500ns/div

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200SG-DPT-EVB

## 5 Schematic Diagram

The electrical schematic diagram of the EVB is shown in Figure 5-1. Various circuit blocks are identified on this diagram to help the user identify or debug the EVB.

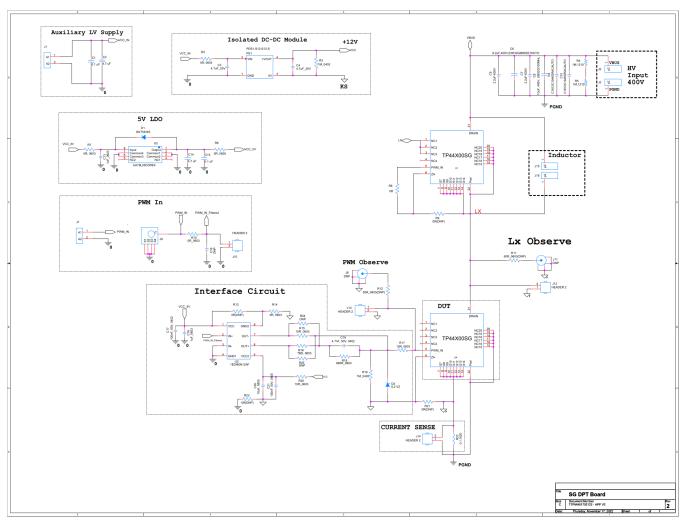


Figure 5-1: Schematic diagram of TP44200SG-DPT-EVB Eval Board.



200SG-DPT-EVB

# 6 Board Layout

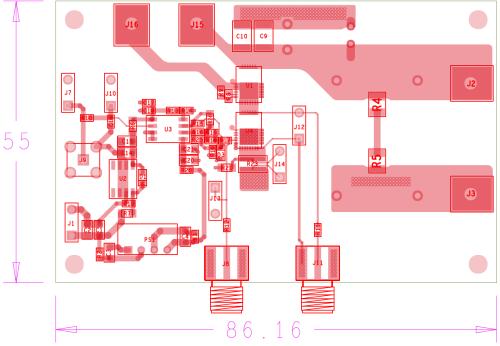


Figure 6-1: EVB PCB Layout of the Top Layer.

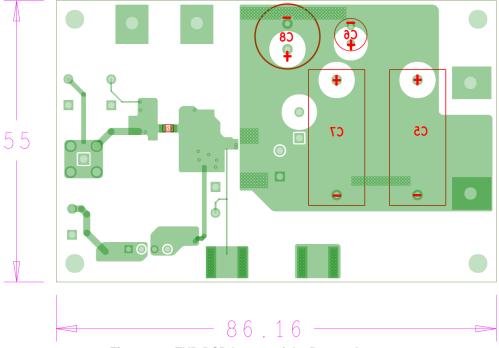


Figure 6-2: EVB PCB Layout of the Bottom Layer.



# 7 Bill Of Materials

### Table 7-1: Bill of Materials (BOM) for TP44200SG-DPT-EVB

TP44200SG-DPT-EVB; BOM Version: 1.1							
SI. #	Qty. Ref. Des.		Part Description	Manufacturer	Manufacturer P/N	Package	
1	1	C1	DNP				
2	1	C15	DNP				
3	1	C2	4.7 uF, 25 V, X7R, 0603	Standard	Standard	0603	
4	1	C14	4.7 uF, 25 V, X7R, 0603	Standard	Standard	0603	
5	1	C3	4.7 uF, 25 V, X7R, 0603	Standard	Standard	0603	
6	1	C4	4.7 uF, 25 V, X7R, 0603	Standard	Standard	0603	
7	1	C5	DNP				
8	1	C7	DNP				
9	1	C6	DNP				
10	1	C8	27 uF, 400 V,	Standard	Standard	TH	
11	1	C9	100 nF, 630 V, X7R, 10%	KEMET	C1812C104KDRACAUT O	1812	
12	1	C10	100 nF, 630 V, X7R, 10%	KEMET	C1812C104KDRACAUT O	1812	
13	1	C13	1 uF, 25 V, X7R, 0603	Standard	Standard	0603	
14	1	C18	1 uF, 25 V, X7R, 0603	Standard	Standard	0603	
15	1	C16	DNP			0603	
16	1	C17	DNP		1	0603	
17	1	C19	4.7 nF, 25 V, X7R, 0603	Standard	Standard	0603	
18	1	C20	4.7 uF, 25 V, X7R, 0805	Standard	Standard	0805	
19	1	C20	100 nF, 25 V, X7R, 0805	Standard	Standard	0805	
20	1	D1	DIODE SCHOTTKY 30 V 200 mA SOD323	Standard	BAT54WS	SOD-323	
20	1	D1 D3	DIODE ZENER 6.2 V 300 mW SOD323	Onsemi	SZMM3Z6V2ST1G	SOD-323	
21	-						
	1	J1 J7	HEADER 2 Pin	Standard	Standard	TH	
23	1	-	HEADER 2 Pin	Standard	Standard	TH	
24	1	J2	Banana Jack Red 4mm	Standard	Standard		
25	1	J15	Banana Jack Red 4mm	Standard	Standard		
26	1	J3	Banana Jack Black 4mm	Standard	Standard		
27	1	J16	Banana Jack Black 4mm	Standard	Standard		
28	1	J8	DNP				
29	1	J11	DNP				
30	1	J9	SMA Connector	Standard	Standard	TH	
31	1	J10	DNP				
32	1	J12	DNP				
33	1	J13	HEADER 2 Pin	Standard	Standard	TH	
34	1	J14	HEADER 2 Pin	Standard	Standard	TH	
35	1	PS1	Isolated DC-DC Converter	CUI Inc.	PDS1-S12-S12-S	TH	
36	1	R2	RES 0 OHM JUMPER 1/10W 0603	Standard	Standard	0603	
37	1	R3	RES 1 MOHM 5% 1/10 W 0603	Standard	Standard	0603	
38	1	R19	RES 1 MOHM 5% 1/10 W 0603	Standard	Standard	0603	
39	1	R4	RES 1 MOHM 5% ½ W 1210	Standard	Standard	1210	
40	1	R5	RES 1 MOHM 5% ½ W 1210	Standard	Standard	1210	
41	1	R6	RES 0 OHM JUMPER 1/8 W 0805	Standard	Standard	0805	
42	1	R7	RES 0 OHM JUMPER 1/10 W 0603	Standard	Standard	0603	
43	1		RES 0 OHM JUMPER 1/10 W 0603	Standard	Standard	0603	
44	1	R9	DNP Standard				
45	1	R13	DNP		1		
46	1	R10	RES 0 OHM JUMPER 1/10 W 0603 Standard		Standard	0603	
40	1	R11	DNP Standard		Otanuaru	0000	
47	1	R12	DNP			1	
40	1	R12	RES 0 OHM JUMPER 1/10 W 0603	Standard	Standard	0603	
-							
50	1	R15	RES 5 OHM 1% 1/10 W 0603 Standa		Standard	0603	
51	1	R17	RES 5 OHM 1% 1/10 W 0603	Standard	Standard	0603	
52	1	R20	RES 10 OHM 1% 1/10 W 0603	Standard	Standard	0603	
53	1	R16	RES 20 OHM 1% 1/10 W 0603	Standard	Standard	0603	
54	1	R18	RES 680 OHM 1% 1/10 W 0603	Standard	Standard	0603	
55	1	R21	DNP				

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	TP44200SG-DPT-EVB; BOM Version: 1.1							
SI. #	Qty.	Ref. Des.	Part Description	Manufacturer	Manufacturer P/N	Package		
56	1	R22	DNP					
57	1	R23	RES 0.100 OHM 1% 1 W 2010	Standard	Standard	1020		
58	1	R24	DNP	DNP				
59	1	R25	DNP					
60	1	U1	GaN E-HEMT	Tagore Technology	TP44200SG	QFN 5X7		
61	1	U4	GaN E-HEMT	Tagore Technology	TP44200SG	QFN 5X7		
62	1	U2	LDO 5V, 100mA	Texas Instruments	UA78L05CDRE4	SOIC-8		
63	1	U3	Gate Drivers 1200V Isolated 1-CH, 9.4 A	Infineon Tech.	1EDI60N12AF	DSO-8		
64	1		EVB PCB	Tagore Technology	TTPMH01702122-APP V2			

### **Revision History**

Document version	Date of release	Description of changes
Rev 1.0	25-Nov-2022	First release
Rev 1.1	25-Sep-2023	Revised: EVB Name, Table 2-1, BOM. Font changed.